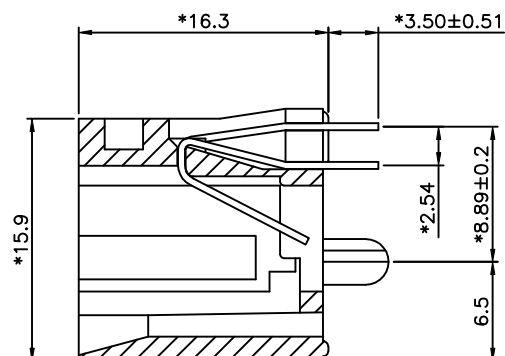
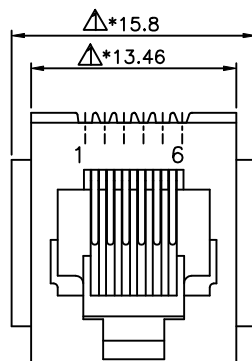


REVISION RECORD				
REV	ECO	DESCRIPTION	DRFT	CHKD
1		DRAWING MODIFY	12/25/00	
2		ADD P/N	06/12/02	
3		ADD P/N	03/08/05	
4		DEL ROHS P/N	08/31/05	
5		ADD&MODIFY P/N	08/29/05	

NOTES:

ELECTRICAL:

- VOLTAGE RATING : 125 VAC RMS MIN.
- CURRENT RATING : 1.5 AMP MIN.
- CONTACT RESISTANCE : 30 MILLIOHMS MAX.
- INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC.
- DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

MECHANICAL:

- HOUSING MATERIAL : GLASS FILLED POLYESTER UL94V-0.
- CONTACT MATERIAL : PHOSPHOR BRONZE $\phi 0.46\text{mm}$.
- PLATING : GOLD PLATING OVER NICKEL.
- OPERATING LIFE : 750 CYCLES MIN. Δ
- PCB RETENTION PRE-SOLDER : 1 LB MIN.
- PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:

- STORAGE : -40°C TO $+85^{\circ}\text{C}$.
- OPERATION: 0°C TO 70°C .

MATES WITH MODULAR PLUG CONFORMING TO
FCC PART 68, SUBPART F.

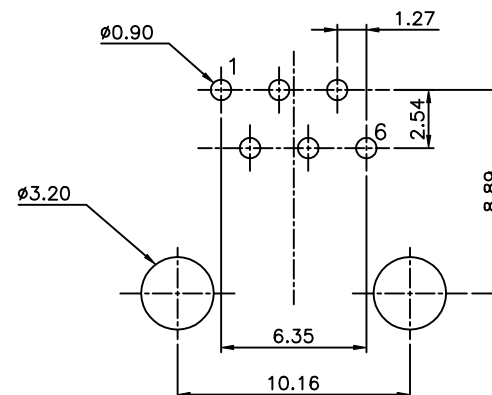
CUL FILE NO. E163191

PART NUMBER: E526X-000X1X

NO. OF CONTACTS
2-2C
4-4C
6-6C

GOLD OF THICKNESS
1-3u" 2-6u"
3-15u" 4-30u"
5-50u" 6-Pd 20u"

0-PBT+15%GF BK
D-PBT+15%GF WHITE Δ
4-PBT+15%GF GY Δ



PC Board Layout
Component Side Shown

DETACHED LISTS	MM (INCH)	DFTO SYZ	DATE 3/4/99	FULL RISE ELECTRONIC CO., LTD	
	TOLERANCES EXCEPT AS NOTED	CHKDLUXIN	DATE 2005/08/29		
	MM	MFO	DATE	TITLE	
	.0 ± 0.20	APPVLLUSHENG	DATE 2005/08/29	TOP ENTRY PCB JACK 6P	
	.00 ± 0.15			DRAWING NO. GE523022	
ANGLES $\pm$		MATERIAL :		/PART NO. SEE NOTE	
THIRD ANGLE PROJECTION		QT'Y :		DRAWING NO. GE523022	
		FINISH :		SHEET X OF Y	
		SCALE : 3:1		DO NOT SCALE DRAWING	